

## PRM6R5N08CTF

## PFC Device Corporation

## 80V Single N-Channel MOSFET

Major ratings and characteristics

| Characteristics | Values | Units |
| :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | 80 | $\mathbf{V}$ |
| $\mathrm{I}_{\mathrm{D}}\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ | 49 | $\mathbf{A}$ |
| Max. $\mathrm{R}_{\mathrm{DS}(0,0} @ \mathrm{~V}_{\mathrm{Gs}}=10 \mathrm{~V}$ | 6.5 | $\mathbf{m} \boldsymbol{\Omega}$ |
| $\mathrm{T}_{J}$ Operating Junction <br> Temperature | -55 to +150 | ${ }^{\circ} \mathbf{C}$ |

## General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

## Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting



## Features

- $\operatorname{Max} . R_{D S(O N)}=6.5 \mathrm{~m} \Omega @ V_{G S}=10 \mathrm{~V}$
- Improved dv/dt capability
- Fast switching
- $100 \% \mathrm{E}_{\mathrm{AS}}$ Guaranteed
- Green Device Available


## 1. Characteristics

Maximum Ratings Characteristics ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise specified)

| Symbol | Parameter | Rating | Units |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DS}}$ | Drain-Source Voltage | 80 | V |
| $\mathrm{~V}_{\mathrm{GS}}$ | Gate-Source Voltage | $\pm 20$ | V |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current - Continuous $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ | 49 | A |
|  | Drain Current - Continuous $\left(\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}\right)$ | 31 | A |
| $\mathrm{I}_{\mathrm{D}}$ | Drain Current - Pulsed ${ }^{1}$ | 196 | A |
| $\mathrm{E}_{\mathrm{AS}}$ | Single Pulse Avalanche Energy ${ }^{2}$ | 180 | mJ |
| $\mathrm{I}_{\mathrm{AS}}$ | Single Pulse Avalanche Current ${ }^{2}$ | 60 | A |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right)$ | 31.2 | W |
|  | Power Dissipation - Derate above $25^{\circ} \mathrm{C}$ | 0.25 | $\mathrm{~W}{ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{J}}$ | Operating Junction Temperature Range | -55 to 150 | ${ }^{\circ} \mathrm{C}$ |

## Thermal Characteristics

| Symbol | Parameter | Typ. | Max. | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{R}_{\text {ӨJA }}$ | Thermal Resistance Junction to ambient | --- | 62 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\mathrm{R}_{\text {ӨJC }}$ | Thermal Resistance Junction to Case | -- | 4 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Characteristics

| Electrical Characteristics $\left(\mathrm{T}_{J}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified $)$ |
| :--- |
| Off Characteristics |
| Symbol Parameter Conditions Min. Typ. Max. Unit <br> $\mathrm{BV}_{\mathrm{DSS}}$ Drain-Source Breakdown Voltage $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mathrm{uA}$ 80 --- --- V <br> $\mathrm{I}_{\mathrm{DSS}}$ Drain-Source Leakage Current $\mathrm{V}_{\mathrm{DS}}=80 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{J}=25^{\circ} \mathrm{C}$ --- --- 1 uA <br> $\mathrm{I}_{\mathrm{GSS}}$ Gate-Source Leakage Current $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ --- --- $\pm 100$ nA |

On Characteristics

| $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | Static Drain-Source On-Resistance | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ | --- | --- | 6.5 | $\mathrm{~m} \Omega$ |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{GS}(\mathrm{th})}$ | Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}}=\mathrm{V}_{\mathrm{DS}}, \mathrm{I}_{\mathrm{D}}=250 \mathrm{uA}$ | 2.0 | --- | 4.0 | V |
| $\mathrm{~g}_{\mathrm{fs}}$ | Forward Transconductance | $\mathrm{V}_{\mathrm{DS}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ | --- | 45 | --- | S |

Dynamic and switching Characteristics

| $\mathrm{Q}_{\mathrm{g}}$ | Total Gate Charge ${ }^{3,4}$ | $\mathrm{V}_{\mathrm{DS}}=40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ | --- | 70 | --- | nC |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{Q}_{\mathrm{qs}}$ | Gate-Source Charge ${ }^{3,4}$ |  | --- | 24 | --- |  |
| $\mathrm{Q}_{\mathrm{gd}}$ | Gate-Drain Charge ${ }^{3,4}$ |  | --- | 23 | --- |  |
| $\mathrm{T}_{\mathrm{d}(\mathrm{on})}$ | Turn-On Delay Time ${ }^{3,4}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{DD}}=40 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{G}}=6 \Omega \\ & \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A} \end{aligned}$ | --- | 35 | --- | ns |
| $\mathrm{T}_{\mathrm{r}}$ | Turn-On Rise Time ${ }^{3,4}$ |  | --- | 106 | --- |  |
| $\mathrm{T}_{\text {d(off) }}$ | Turn-Off Delay Time ${ }^{3,4}$ |  | --- | 36 | --- |  |
| Tf | Turn-Off Fall Time ${ }^{3,4}$ |  | --- | 35 | --- |  |
| $\mathrm{C}_{\text {iss }}$ | Input Capacitance | $\mathrm{V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | --- | 4400 | --- | pF |
| $\mathrm{C}_{\text {oss }}$ | Output Capacitance |  | --- | 450 | --- |  |
| $\mathrm{C}_{\text {rss }}$ | Reverse Transfer Capacitance |  | --- | 210 | --- |  |
| $\mathrm{R}_{\mathrm{g}}$ | Gate resistance | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | --- | 0.8 | --- | $\Omega$ |

## Drain-Source Diode Characteristics

| $\mathrm{V}_{\mathrm{SD}}$ | Source to Drain Diode Voltage | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{S}}=20 \mathrm{~A}$ | --- | --- | 1.5 | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{rr}}$ | Reverse Recovery Time | $\mathrm{I}_{\mathrm{S}}=20 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mathrm{us}$ | --- | 31 | --- | ns |
| $\mathrm{Q}_{\mathrm{rr}}$ | Reverse Recovery Charge |  | --- | 27 | --- | nC |

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{D D}=50 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~L}=0.1 \mathrm{mH}, \mathrm{I}_{\mathrm{AS}}=60 \mathrm{~A}, \mathrm{R}_{\mathrm{G}}=25 \Omega$, Starting $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$
3. The data tested by pulsed, pulse width $\leqq 300$ us, duty cycle $\leqq 2 \%$.
4. Essentially independent of operating temperature.

## 2. Characteristics Curves



Figure 1: Power Dissipation


Figure 3: Normalized $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ vs. $\mathrm{T}_{\mathrm{J}}$


Figure 2: Continuous Drain Current vs. $\mathrm{T}_{\mathrm{C}}$


Figure 4: Normalized $\mathbf{V G S}_{\mathbf{G S}(\mathrm{th})}$ vs. $\mathrm{T}_{\mathbf{J}}$


Figure 5: On-Region Characteristics


Figure 7: Typ. Capacitance Characteristics
( $\mathrm{T}_{\mathrm{A}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$ unless otherwise specified)


Figure 6: Typ. $\mathrm{R}_{\mathrm{DS}}$ Variation vs. $\mathrm{I}_{\mathrm{D}}$ and $\mathrm{V}_{\mathrm{GS}}$


Figure 8: Typ. Gate Charge Characteristics


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case


Figure 10: Maximum Safe Operation Area

## 3. Marking information

## Top Marking Rule

## PFC PRM 6R5N08CTF YYWW ABSH

PRM6R5N08CTF = Product Type Marking Code
YYWW = Date Code
$Y Y=$ Last two digits of year
WW = Week code
ABS = Assembly code
$H$ = Halogen Free (N/A = common molding compound)

## 4. Package information

## Package Outline Dimensions millimeters



## 5. Ordering information

| Part Number | Package | Delivery mode |
| :---: | :--- | :--- |
| PRM6R5N08CTF | ITO-220AB | 50 pcs / Tube |

## Mechanical

- Molder Plastic: UL Flammability Classification Rating 94V-0

■ Device Weight : 0.06 ounces (1.74grams) - ITO-220AB

- Mounting Torque : Recommended $4 \sim 5 \mathrm{~kg}-\mathrm{cm}$

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